

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Ching-Hsu CHANG</td> <td>08/11/2010</td> </tr> <tr> <td>Hung-Chun WANG</td> <td>08/11/2010</td> </tr> <tr> <td>Boren LUO</td> <td>08/11/2010</td> </tr> <tr> <td>Wen-Chun HUANG</td> <td>08/11/2010</td> </tr> <tr> <td>Ru-Gun LIU</td> <td>08/11/2010</td> </tr> </tbody> </table>		Name	Execution Date	Ching-Hsu CHANG	08/11/2010	Hung-Chun WANG	08/11/2010	Boren LUO	08/11/2010	Wen-Chun HUANG	08/11/2010	Ru-Gun LIU	08/11/2010
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.</td> </tr> <tr> <td>Street Address:</td> <td>No. 8, Li-Hsin Rd. VI, Hsinchu Science Park</td> </tr> <tr> <td>City:</td> <td>Hsinchu</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> <tr> <td>Postal Code:</td> <td>300</td> </tr> </table>		Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.	Street Address:	No. 8, Li-Hsin Rd. VI, Hsinchu Science Park	City:	Hsinchu	State/Country:	TAIWAN	Postal Code:	300		
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CORRESPONDENCE DATA													
Fax Number: (703)518-5499 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 7036841111 Email: sramunto@ipfirm.com Correspondent Name: Lowe Hauptman Ham & Berner, LLP (TSMC) Address Line 1: 1700 Diagonal Road, Suite 300 Address Line 4: Alexandria, VIRGINIA 22314													
ATTORNEY DOCKET NUMBER:	T5057-Y285												
NAME OF SUBMITTER:	Yoon S. Ham												

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PATENT
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Total Attachments: 1
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Docket No. T5057-Y285

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- | | |
|--------------------|-------------------|
| 1) Ching-Hsu CHANG | 4) Wen-Chun HUANG |
| 2) Hung-Chun WANG | 5) Ru-Gun LIU |
| 3) Boren LUO | |

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD. having a place of business at No. **8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.**

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

EXTREME ULTRAVIOLET LIGHT (EUV) PHOTOMASKS, AND FABRICATION METHODS THEREOF

(a) for which an application for United States Letters Patent was filed on 8-17-10, and identified by United States Patent Application No. 12/858,159; or

(b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Ching-Hsu Chang
Name: Ching-Hsu CHANG

2010.08.11
Date:

2) Hung-Chun Wang
Name: Hung-Chun WANG

2010/08/11
Date:

3) Boren Luo
Name: Boren LUO

2010.08.11
Date:

4) Wen-Chun Huang
Name: Wen-Chun HUANG

2010.08.11
Date:

5) Ru-Gun Liu
Name: Ru-Gun LIU

2010/08/11
Date: